

# FUJI POWER MOSFET Super FAP-G Series

## N-CHANNEL SILICON POWER MOSFET

### ■ Features

**High speed switching**

**Low on-resistance**

**No secondary breakdown**

**Low driving power**

**Avalanche-proof**

### ■ Applications

**Switching regulators**

**UPS (Uninterruptible Power Supply)**

**DC-DC converters**

### ■ Maximum ratings and characteristic

#### ● (Tc=25°C unless otherwise specified)

Item	Symbol	Ratings	Unit
Drain-source voltage	VDS	200	V
	VDSX *5	170	V
Continuous drain current	Id	±13	A
Pulsed drain current	Id(puls)	±52	A
Gate-source voltage	VGS	±30	V
Non-repetitive Avalanche current	IAS *2	13	A
Maximum Avalanche Energy	EAS *1	175	mJ
Maximum Drain-Source dV/dt	dVds/dt *4	20	kV/μs
Peak Diode Recovery dV/dt	dV/dt *3	5	kV/μs
Max. power dissipation	Pd	Ta=25°C Tc=25°C	2.02 50
Operating and storage temperature range	Tch	+150	°C
	Tsig	-55 to +150	°C

\*1 L=1.65mH, Vcc=48V    \*2 Tch≤150°C    \*3 IF≤ -Id, -di/dt=50A/μs, Vcc≤BVdss, Tch≤150°C

\*4 Vds ≤ 200V    \*5 Vgs=-30V

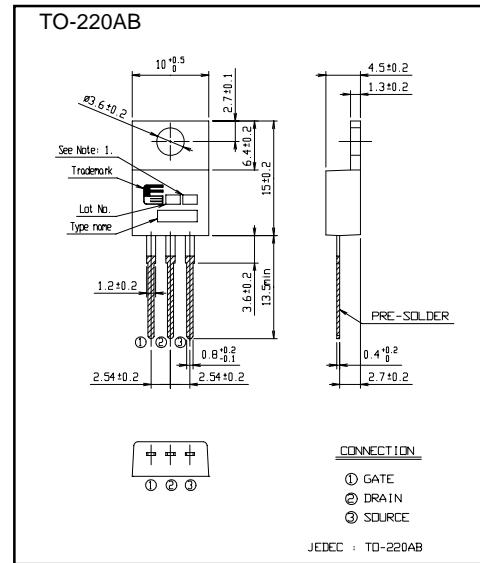
#### ● Electrical characteristics (Tc =25°C unless otherwise specified)

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	V(BR)DSS	Id= 250μA VGS=0V	200			V
Gate threshold voltage	VGS(th)	Id= 250μA VDS=VGS	3.0		5.0	V
Zero gate voltage drain current	IdSS	VDS=200V VGS=0V VDS=160V VGS=0V	Tch=25°C Tch=125°C		25 250	μA
Gate-source leakage current	IGSS	VGS=±30V VDS=0V		10	100	nA
Drain-source on-state resistance	RDS(on)	Id=6.5A VGS=10V		131	170	mΩ
Forward transconductance	gfs	Id=6.5A VDS=25V	5.5	11		S
Input capacitance	Ciss	VDS=75V VGS=0V f=1MHz		770	1155	pF
Output capacitance	Coss			110	165	
Reverse transfer capacitance	Crss			5	7.5	
Turn-on time ton	td(on)	Vcc=48V Id=6.5A VGS=10V RGS=10 Ω		12	18	ns
	tr			2.6	3.9	
Turn-off time toff	td(off)			22	33	
	tf			6.1	9.2	
Total Gate Charge	QG	Vcc=100V Id=13A VGS=10V		21	31.5	nC
Gate-Source Charge	QGS			8	12	
Gate-Drain Charge	QGD			5	7.5	
Avalanche capability	IAV	L=100μH Tch=25°C	13			A
Diode forward on-voltage	VSD	IF=13A VGS=0V Tch=25°C		1.10	1.65	V
Reverse recovery time	trr	IF=13A VGS=0V -di/dt=100A/μs Tch=25°C		0.15		μs
Reverse recovery charge	Qrr			0.88		μC

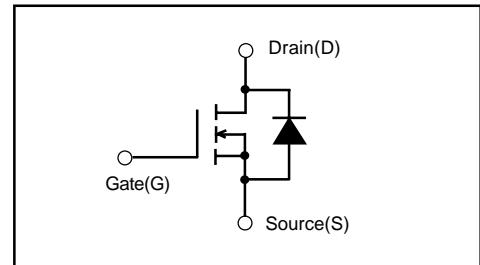
### ● Thermal characteristics

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	Rth(ch-c)	channel to case			2.5	°C/W
	Rth(ch-a)	channel to ambient			62.0	°C/W

### ■ Outline Drawings (mm)



### ■ Equivalent circuit schematic



## Characteristics

